NCE2321

NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE2321 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications.

General Features

• $V_{DS} = -20V, I_{D} = -3.9A$

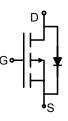
 $R_{DS(ON)}$ <70m Ω @ V_{GS} =-2.5V

 $R_{DS(ON)} < 50 \text{m}\Omega$ @ V_{GS} =-4.5V

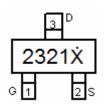
- High power and current handing capability
- Lead free product is acquired
- Surface mount package

Application

- PA switch
- Load switch
- Power management



Schematic diagram



Marking and pin assignment



SOT-23 top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
2321 X	NCE2321	SOT-23	Ø180mm	8 mm	3000 units

Absolute Maximum Ratings (T_A=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	-20	V	
Gate-Source Voltage	V _{GS}	±12	V	
Drain Current -Continuous	I _D	-3.9	Α	
Drain Current -Pulsed (Note 1)	I _{DM}	-12	Α	
Maximum Power Dissipation	P _D	1.4	W	
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	$^{\circ}$ C	

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ heta JA}$	89	°C/W

Electrical Characteristics (T_A =25 $^{\circ}$ C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250μA	-20	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-20V,V _{GS} =0V	-	-	-1	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±12V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)				•		
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-250μA	-0.45	-0.7	-1.0	V
Desire Courses On Otata Basistana	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-3.3A	-	37	50	mΩ
Drain-Source On-State Resistance		V _{GS} =-2.5V, I _D =-3.0A	-	48	70	
Forward Transconductance	g FS	V _{DS} =-5V,I _D =-3.0A	5	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	V _{DS} =-10V,V _{GS} =0V,	-	560	-	PF
Output Capacitance	Coss	F=1.0MHz	-	80	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.UIVIFIZ	-	70	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	12	-	nS
Turn-on Rise Time	t _r	V_{DD} =-10V, I_{D} =-3.3A ,	-	35	-	nS
Turn-Off Delay Time	t _{d(off)}	R_L =2.2 Ω , V_{GS} =-4.5 V , R_g =6 Ω	-	55	-	nS
Turn-Off Fall Time	t _f		-	40	-	nS
Total Gate Charge	Qg		-	8.5	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =-10V,I _D =-3.3A,V _{GS} =-4.5V	-	1.2	-	nC
Gate-Drain Charge	Q_{gd}]	-	2.1	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-3.9A	-	-	-1.2	V
Diode Forward Current (Note 2)	Is		-	-	-3.9	Α

Notes:

- $\textbf{1.} \ \textbf{Repetitive Rating: Pulse width limited by maximum junction temperature}.$
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

50%



Typical Electrical and Thermal Characteristics

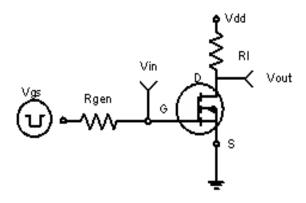


Figure 1:Switching Test Circuit

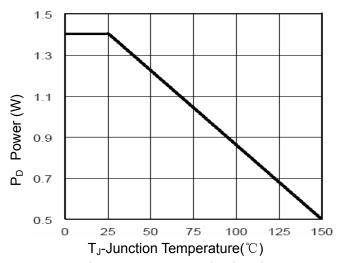
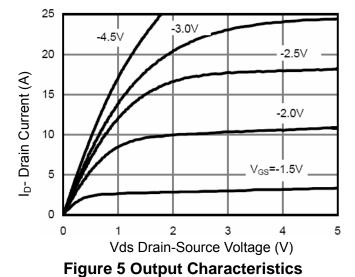


Figure 3 Power Dissipation



 $t_{d(on)} \rightarrow t_{on} \rightarrow t_{off} \rightarrow t_{d(off)} \rightarrow t_{f} \rightarrow t_{g0\%} \rightarrow t_$

Figure 2:Switching Waveforms

PULSE WIDTH

V_{IN}

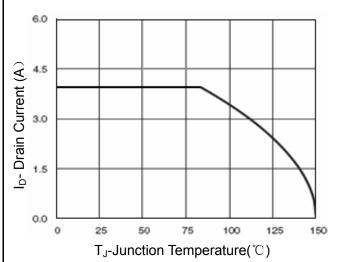


Figure 4 Drain Current

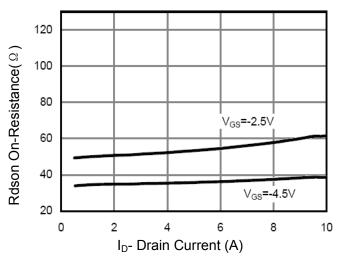


Figure 6 Drain-Source On-Resistance



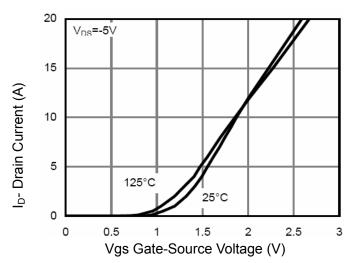


Figure 7 Transfer Characteristics

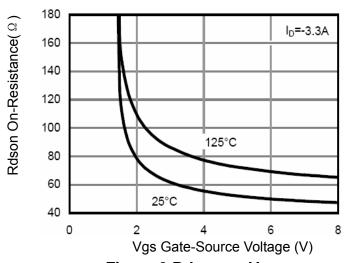
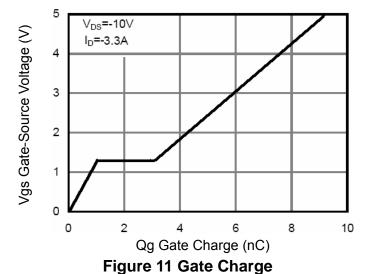


Figure 9 Rdson vs Vgs



1.6 V_{GS}=-4.5V I_D=-3.3A Normalized On-Resistance 1.4 1.2 V_{GS}=-2.5V I_D=-3A 1 0.8 75 100 125 150 175 T_J-Junction Temperature(°C)

Figure 8 Drain-Source On-Resistance

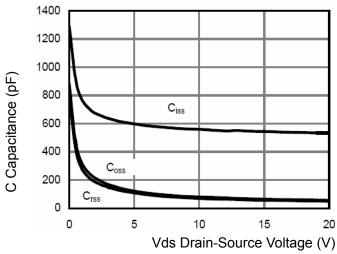


Figure 10 Capacitance vs Vds

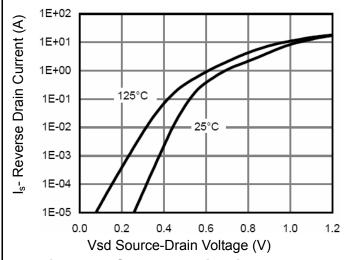


Figure 12 Source- Drain Diode Forward



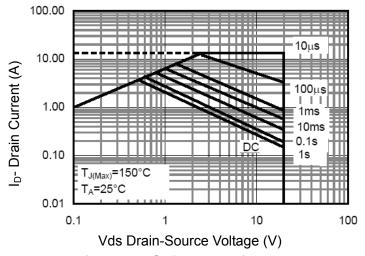


Figure 13 Safe Operation Area

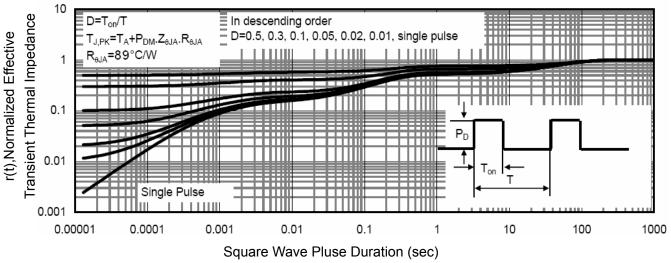
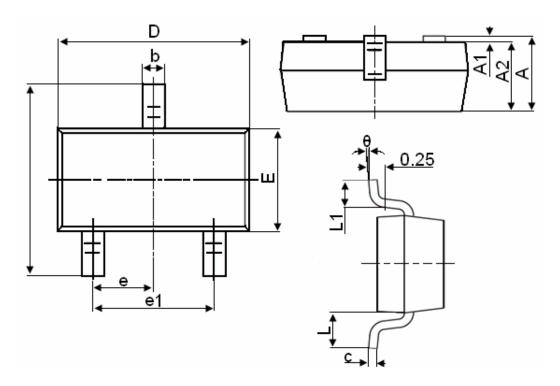


Figure 14 Normalized Maximum Transient Thermal Impedance



SOT-23 Package Information



Cumbal	Dimensions in Millimeters				
Symbol	MIN.	MAX.			
А	0.900	1.150			
A1	0.000	0.100			
A2	0.900	1.050			
b	0.300	0.500			
С	0.080	0.150			
D	2.800	3.000			
E	1.200	1.400			
E1	2.250	2.550			
е		0.950TYP			
e1	1.800	2.000			
L		0.550REF			
L1	0.300	0.500			
θ	0°	8°			

Notes

- 1. All dimensions are in millimeters.
- 2. Tolerance ±0.10mm (4 mil) unless otherwise specified
- 3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.
- 4. Dimension L is measured in gauge plane.
- $5. \ Controlling \ dimension \ is \ millimeter, \ converted \ inch \ dimensions \ are \ not \ necessarily \ exact.$



http://www.ncepower.com

NCE2321

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